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March 2016

SS15FA - S115FA 1 A, 50 V - 150 V Surface Mount Schottky Barrier Rectifiers

Features

- · Low Power Loss, High Efficiency
- · Guard Ring for Overvoltage Protection
- · High Surge Current Capability
- UL Flammability 94V-0 Classification
- MSL 1 per J-STD-020
- · RoHS Compliant / Green Molding Compound
- Industrial Device Qualified per AEC-Q101 Standards
 - * See authorized use policy



SOD-123FA



Ordering Information

Part Number	Top Mark	Package	Packing Method	
SS15FA	15L	SOD-123FA	Tape and Reel	
SS16FA	16L	SOD-123FA	Tape and Reel	
SS19FA	19L	SOD-123FA	Tape and Reel	
S110FA	10L	SOD-123FA	Tape and Reel	
S115FA	1AL	SOD-123FA	Tape and Reel	

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25$ °C unless otherwise noted.

	Parameter		Value				
Symbol			SS16 FA	SS19 FA	S110 FA	S115 FA	Unit
V_{RRM}	Repetitive Peak Reverse Voltage		60	90	100	150	V
V _{RMS}	RMS Reverse Voltage	35	42	63	70	105	V
V _R	DC Blocking Voltage	50	60	90	100	150	V
I _{F(AV)}	Average Forward Rectified Current		1				
I _{FSM}	Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load 30				Α		
T _J	Operating Junction Temperature Range		-55 to +150				°C
T _{STG}	Storage Temperature Range		-55 to +150				°C

Thermal Characteristics(1)

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Value	Unit
ΨJL	Thermal Characteristics, Junction-to-Lead	16	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	152	°C/W

Note:

1. Per JESD51-3 Recommended Thermal Test Board. Device mounted on FR-4 PCB, board size = 76.2mm x 114.3mm.

Electrical Characteristics

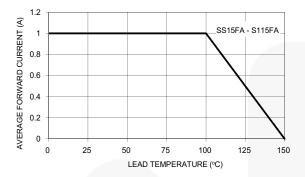
Values are at T_A = 25°C unless otherwise noted.

		Conditions	Value					
Symbol	Parameter		SS15 FA	SS16 FA	SS19 FA	S110 FA	S115 FA	Unit
V		I _F = 0.5 A	0.58		0.70		0.75	V
V _F Forward Vo	Forward Voltage ⁽²⁾	I _F = 1.0 A	0.70		0.80		0.90	
		T _J = 25°C	0.4		0.05			
	Maximum Reverse Current at Rated V _R	T _J = 100°C	6.0					mA
	at rated v _R	T _J = 125°C			0.5			
СЈ	Typical Junction Capacitance	V _R = 4 V, f = 1 MHz	54		35			pF
T _{rr}	Typical Reverse Recovery Time	$I_F = 0.5 A,$ $I_R = 1 A,$ $I_{RR} = 0.25 A$	5.6 8.3			ns		

Note:

2. Pulse test with PW = 300 μ s, 1% duty cycle

Typical Performance Characteristics



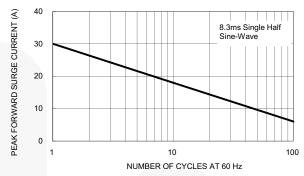
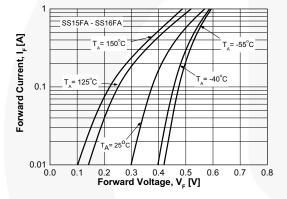


Figure 1. Forward Current Derating Curve

Figure 2. Maximum Non-Repetitive Forward Surge Curren



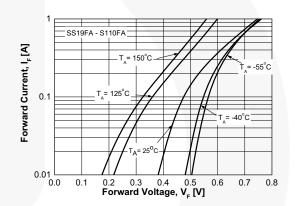
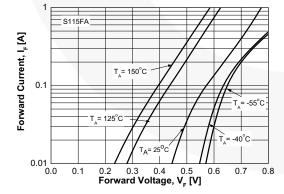


Figure 3. Typical Forward Characteristics

Figure 4. Typical Forward Characteristics



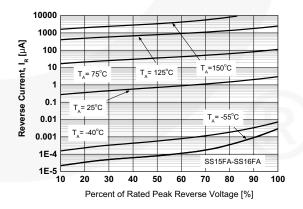


Figure 5. Typical Forward Characteristics

Figure 6. Typical Reverse Characteristics

Typical Performance Characteristics (Continued)

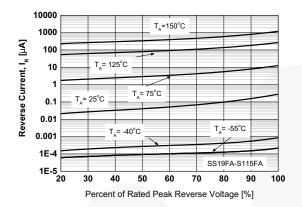


Figure 7. Typical Reverse Characteristics

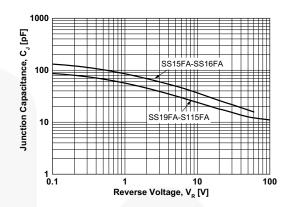
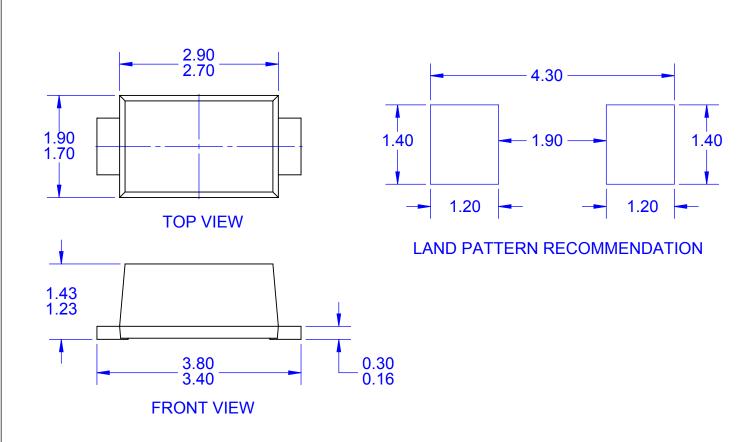
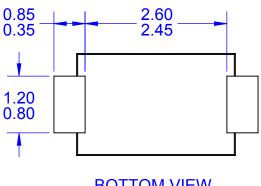


Figure 8. Typical Junction Capacitance





BOTTOM VIEW

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Definition of Terms

Deminition of Terms						
Datasheet Identification		Definition				
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.				
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.				
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.				
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.				

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